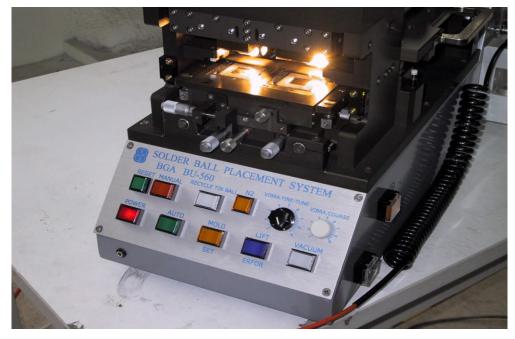
WEIDACHENG INDUSYRY CO., LTD

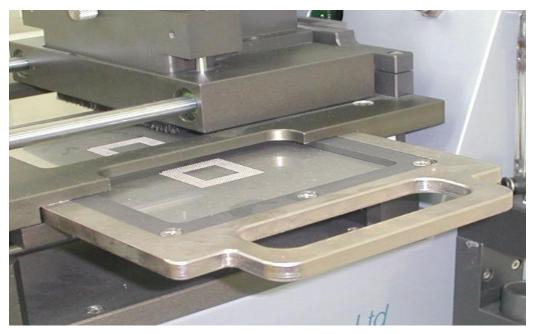
http://www.bga500.com.twE-mail:bga500@ms23.hinet.netPRESS-FIT PLACEMENT'SYSTEMBU-565Ball placement capability:Φ 0.35 ~Φ 0.76Ball placement range:L-65mm.W-80mm



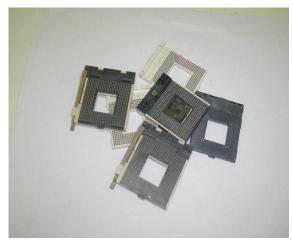
X-Y- θ Theta positioning slider with micrometers adjustment & BGA fixtures.



Drawable solder ball mask cassette base.



All kinds of BGA substrate solder ball placement.



Pin-array socket fixture.



Solder ball collecting bottle base. (Ball cleaning device)



BGA Pin-array transfer printing + solder ball placement will be launched soon. Please query.

BGA rework equipment --- Solder ball placement system BU-565

(1) ■ Outside dimension: 75cm(L), 25cm(W), 26cm(H).

(2) Weight: 38 kg.

- (3) Working voltage: AC-110V;50/60Hz / AC-220V;50/60Hz
- (4) Working air pressure: 6 kg/cm².
- (5) Solder ball specification: According to the solder ball spec being used by different kinds of BGA package.
- (6) **BGA IC holder: It is available for changing-over different types of BGA IC holders** according to different size or spec of BGA package.
- (7) Solder ball screening fixture: It is available for changing-over different ball screening fixtures according to different size or spec of solder ball.
- (8) Solder ball placing speed: The speed for placing solder balls onto BGA pads can be adjusted and fine-tuning controlled.
- (9) Ball-placing yield rate: 98%.
- (10) Ball-placing accuracy: 0.03mm.
- (11) BGA IC holder unloading speed: Unloading speed 30~300 mm/s.
- (12) Automatic ball-placing operation cycle time : 22 seconds.

BGA regeneration!

 \sim Place solder balls on BGA to regenerate a whole new one with the lowest cost. \sim

The solder ball placement system places new solder balls again onto ball removed BGA-IC for new reflowing rework. This equipment provides a technology promotion for traditional BGA operation in SMT industry. It is a very useful tool for BGA production.

[There are patents approved by lots of countries for this equipment. All rights are reserved]